

MOS FIELD EFFECT TRANSISTOR 2SK2461

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK2461 is N-Channel MOS Field Effect Transistor designed for high speed switching applications.

FEATURES

· Low On-Resistance

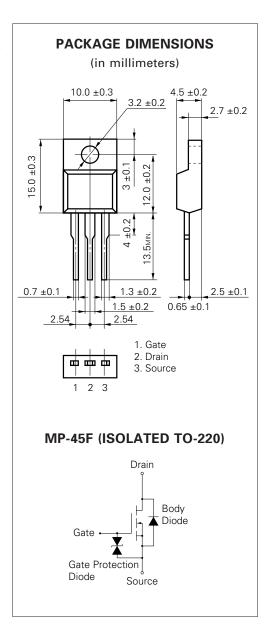
 $R_{DS(on)1} = 80 \text{ m}\Omega \text{ MAX.}$ (@ VGS = 10 V, ID = 10 A) $R_{DS(on)2} = 0.1 \Omega \text{ MAX.}$ (@ VGS = 4 V, ID = 10 A)

- Low Ciss Ciss = 1400 pF TYP.
- Built-in G-S Gate Protection Diodes
- High Avalanche Capability Ratings

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage	VDSS	100	V
Gate to Source Voltage	Vgss	±20	V
Drain Current (DC)	ID(DC)	±20	Α
Drain Current (pulse)*	D(pulse)	±80	Α
Total Power Dissipation ($T_c = 25$ °C)	P _{T1}	35	W
Total Power Dissipation (TA = 25 $^{\circ}$ C)	P _{T2}	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	T_{stg}	-55 to +150	°C
Single Avalanche Current**	las	20	Α
Single Avalanche Energy**	Eas	40	mJ

- * PW \leq 10 μ s, Duty Cycle \leq 1 %
- ** Starting Tch = 25 °C, Rg = 25 Ω , Vgs = 20 V \rightarrow 0



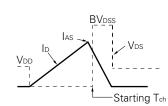


ELECTRICAL CHARACTERISTICS (TA = 25 °C)

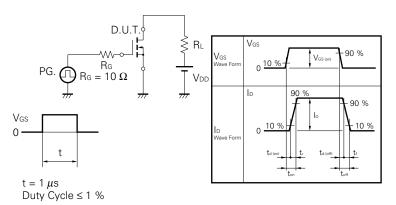
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-Resistance	RDS(on)1		58	80	mΩ	Vgs = 10 V, ID = 10 A
Drain to Source On-Resistance	R _{DS(on)2}		70	100	mΩ	Vgs = 4 V, ID = 10 A
Gate to Source Cutoff Voltage	V _{GS(off)}	1.0	1.7	2.0	V	V _{DS} = 10 V, I _D = 1 mA
Forward Transfer Admittance	l yfs l	12	19		S	V _{DS} = 10 V, I _D = 10 A
Drain Leakage Current	IDSS			10	μΑ	V _{DS} = 100 V, V _{GS} = 0
Gate to Source Leakage Current	Igss			±10	μΑ	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0$
Input Capacitance	Ciss		1400		pF	V _{DS} = 10 V
Output Capacitance	Coss		470		pF	V _G S = 0
Reverse Transfer Capacitance	Crss		150		pF	f = 1 MHz
Turn-On Delay Time	td(on)		21		ns	ID = 10 A
Rise Time	tr		110		ns	V _{GS(on)} = 10 V
Turn-Off Delay Time	td(off)		140		ns	V _{DD} = 50 V
Fall Time	tf		110		ns	$R_G = 10 \Omega$
Total Gate Charge	Q G		51		nC	ID = 20 A
Gate to Source Charge	Qgs		4.9		nC	V _{DD} = 80 V
Gate to Drain Charge	QgD		15		nC	V _{GS} = 10 V
Body Diode Forward Voltage	V _{F(S-D)}		1.1		V	IF = 20 A, VGS = 0
Reverse Recovery Time	trr		170		ns	IF = 20 A, VGS = 0
Reverse Recovery Charge	Qrr		770		nC	di/dt = 100 A/μs

Test Circuit 1 Avalanche Capability

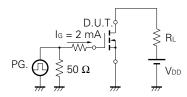
$\begin{array}{c} D.U.T. \\ R_G = 25 \Omega \\ V_{GS} = 20 \rightarrow 0 \end{array}$



Test Circuit 2 Switching Time

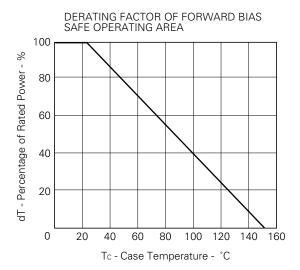


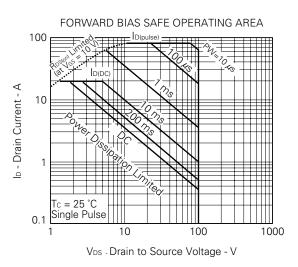
Test Circuit 3 Gate Charge

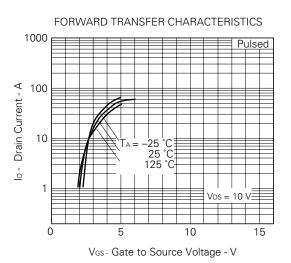


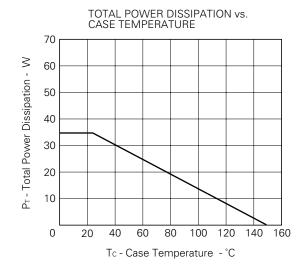
The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

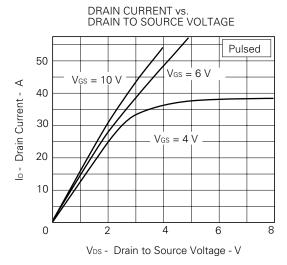
TYPICAL CHARACTERISTICS (TA = 25 °C)





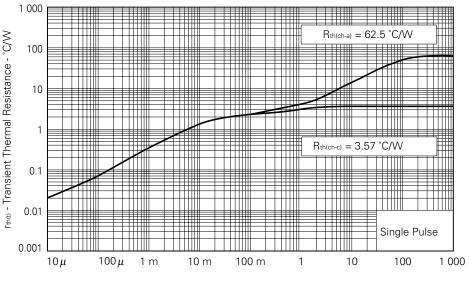






NEC

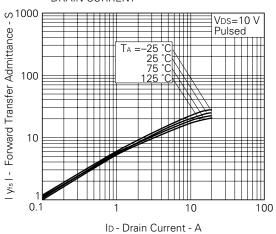
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

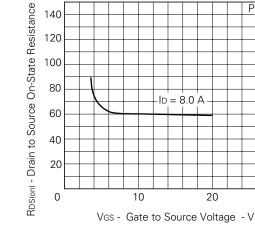


PW - Pulse Width - s

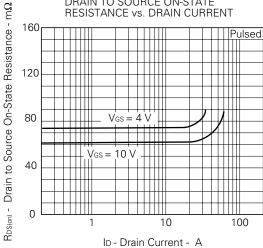
- m

FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT





DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

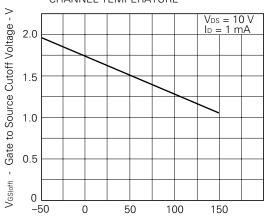


GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE

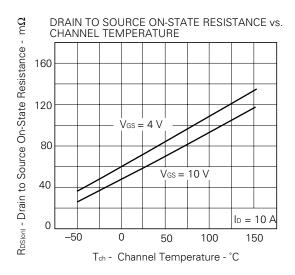
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

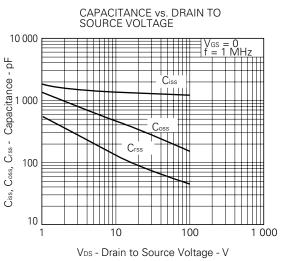
Pulsed

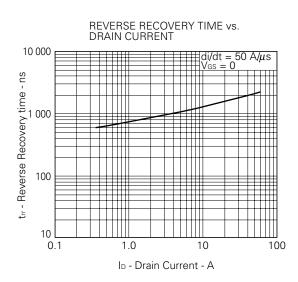
30

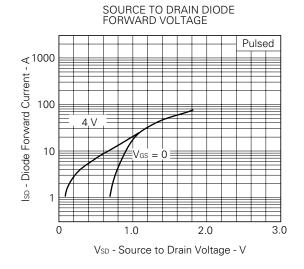


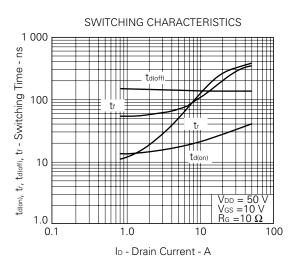
Tch - Channel Temperature - °C

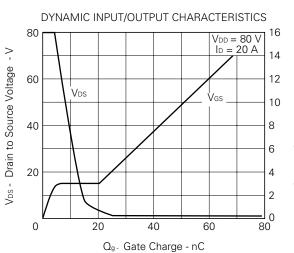




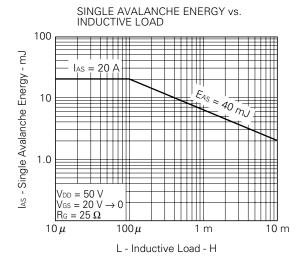


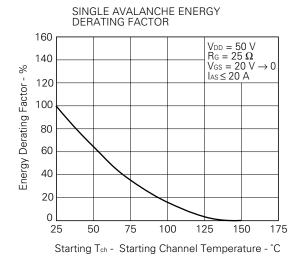














REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

7

[MEMO]

No part of this document may be copied or reproduced in any form or by any means without the prior written consent of NEC Corporation. NEC Corporation assumes no responsibility for any errors which may appear in this document.

NEC Corporation does not assume any liability for infringement of patents, copyrights or other intellectual property rights of third parties by or arising from use of a device described herein or any other liability arising from use of such device. No license, either express, implied or otherwise, is granted under any patents, copyrights or other intellectual property rights of NEC Corporation or others.

While NEC Corporation has been making continuous effort to enhance the reliability of its semiconductor devices, the possibility of defects cannot be eliminated entirely. To minimize risks of damage or injury to persons or property arising from a defect in an NEC semiconductor device, customer must incorporate sufficient safety measures in its design, such as redundancy, fire-containment, and anti-failure features.

NEC devices are classified into the following three quality grades:

"Standard", "Special", and "Specific". The Specific quality grade applies only to devices developed based on a customer designated "quality assurance program" for a specific application. The recommended applications of a device depend on its quality grade, as indicated below. Customers must check the quality grade of each device before using it in a particular application.

Standard: Computers, office equipment, communications equipment, test and measurement equipment, audio and visual equipment, home electronic appliances, machine tools, personal electronic equipment and industrial robots

Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)

Specific: Aircrafts, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

The quality grade of NEC devices in "Standard" unless otherwise specified in NEC's Data Sheets or Data Books. If customers intend to use NEC devices for applications other than those specified for Standard quality grade, they should contact NEC Sales Representative in advance.

Anti-radioactive design is not implemented in this product.